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	Application No.	Applicant(s)
Notice of Allowability	10/797,504	AKRAM, SALMAN
	Examiner	Art Unit
	Hsien-ming Lee	2823
The MAILING DATE of this communication apperatus All claims being allowable, PROSECUTION ON THE MERITS IS herewith (or previously mailed), a Notice of Allowance (PTOL-85) NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RIOF of the Office or upon petition by the applicant. See 37 CFR 1.313	(OR REMAINS) CLOSED in this ap or other appropriate communication IGHTS. This application is subject to	plication. If not included will be mailed in due course. THIS
1. This communication is responsive to <u>5/12/2006</u> .		
2. X The allowed claim(s) is/are 1-16,18-24 and 78-86.		
3. Acknowledgment is made of a claim for foreign priority ur  a) All b) Some* c) None of the:  1. Certified copies of the priority documents have  2. Certified copies of the priority documents have  3. Copies of the certified copies of the priority do  International Bureau (PCT Rule 17.2(a)).  * Certified copies not received:  Applicant has THREE MONTHS FROM THE "MAILING DATE"	e been received. e been received in Application No cuments have been received in this	national stage application from the
noted below. Failure to timely comply will result in ABANDONMENT of this application.  THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.  4.   A SUBSTITUTE OATH OR DECLARATION must be submitted. Note the attached EXAMINER'S AMENDMENT or NOTICE OF		
INFORMAL PATENT APPLICATION (PTO-152) which gives reason(s) why the oath or declaration is deficient.  5.  CORRECTED DRAWINGS (as "replacement sheets") must be submitted.		
(a) ☐ including changes required by the Notice of Draftsperson's Patent Drawing Review ( PTO-948) attached		
1) hereto or 2) to Paper No./Mail Date		
(b) ☐ including changes required by the attached Examiner's Amendment / Comment or in the Office action of Paper No./Mail Date  Identifying indicia such as the application number (see 37 CFR 1.84(c)) should be written on the drawings in the front (not the back) of		
each sheet. Replacement sheet(s) should be labeled as such in the header according to 37 CFR 1.121(d).		
<ol> <li>DEPOSIT OF and/or INFORMATION about the deposit of BIOLOGICAL MATERIAL must be submitted. Note the attached Examiner's comment regarding REQUIREMENT FOR THE DEPOSIT OF BIOLOGICAL MATERIAL.</li> </ol>		
Attachment(s)	E □ Nation of Informal I	Patent Application (PTO-152)
<ol> <li>Notice of References Cited (PTO-892)</li> <li>Notice of Draftperson's Patent Drawing Review (PTO-948)</li> </ol>	6. ☐ Interview Summary	
	Paper No./Mail Da	ate
<ol> <li>Information Disclosure Statements (PTO-1449 or PTO/SB/ Paper No./Mail Date</li> </ol>		
4. Examiner's Comment Regarding Requirement for Deposit of Biological Material	8. 🛛 Examiner's Statem	ent of Reasons for Allowance
-	9.  Other	
		HSIEN-MING LEED PRIMARY EXAMINED 5/23/06

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## **DETAILED ACTION**

## Remarks

1. The 112-second paragraph rejection, as set forth in the previous office action, has been withdrawn in response to applicant's amendment filed 5/12/2006.

## Examiner's Amendment

2. An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

Authorization for this examiner's amendment was given in a telephone interview with Craig Buschmann (Reg. No. 57,829) on May 23, 2006.

3. The application has been amended as follows:

In claim 15 (line 4) and claim 22 (line 4), replace "mutual" with -- relative --.

## Allowable Subject Matter

- 4. Claims 1-16, 18-24 and 78-86 are allowed.
- 5. The following is an examiner's statement of reasons for allowance:

The prior art of record at least neither teaches nor suggests "cutting from the active surface of the semiconductor wafer body through the semiconductor wafer body with at least one laser beam along the plurality of streets between the active surface of the semiconductor wafer body and the at least one trench" and "traversing the at least one laser beam to impinge the semiconductor wafer body along a path and substantially concurrently traversing the at least

another laser beam to impinge the semiconductor wafer body along the same path subsequent to impingement of the at least one laser beam."

- 6. Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."
- 7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Hsien-ming Lee whose telephone number is 571-272-1863. The examiner can normally be reached on Tuesday-Thursday ( $7:30 \sim 6:00$ ).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Matthew Smith can be reached on 571-272-1907. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

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Hsien-ming Lee Primary Examiner
Art Unit 2823

May 23, 2006

HSIEN-MING LEE PRIMARY EXAMINED 5/23/06